

2SC3937

Silicon NPN epitaxial planar type

For UHF band low-noise amplification

■ Features

- Low noise figure NF
- High forward transfer gain $|S_{21e}|^2$
- High transition frequency f_T
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

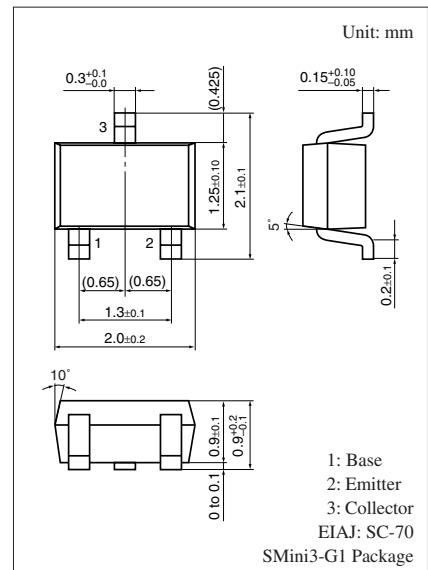
■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V_{CBO}	15	V
Collector-emitter voltage (Base open)	V_{CEO}	10	V
Emitter-base voltage (Collector open)	V_{EBO}	2	V
Collector current	I_C	80	mA
Collector power dissipation	P_C	150	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

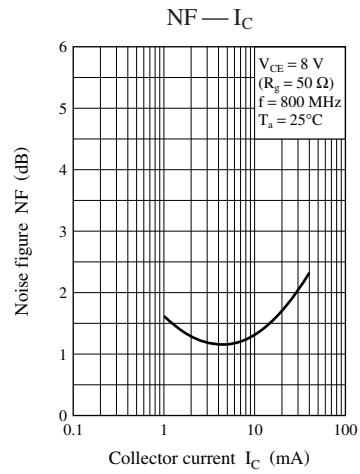
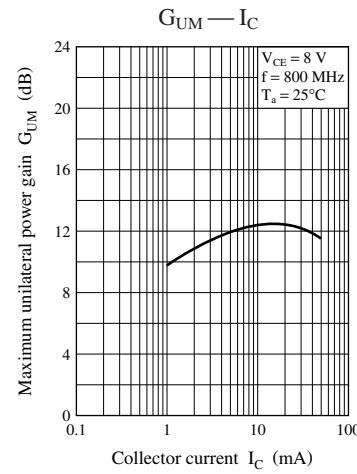
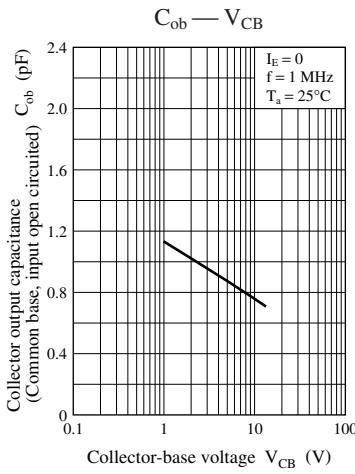
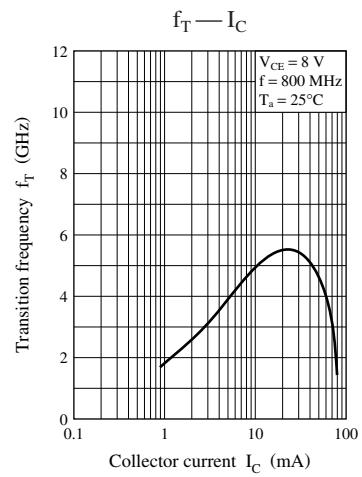
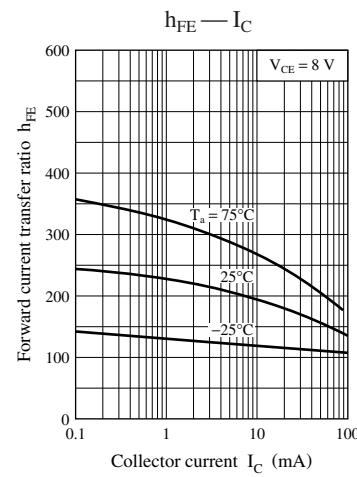
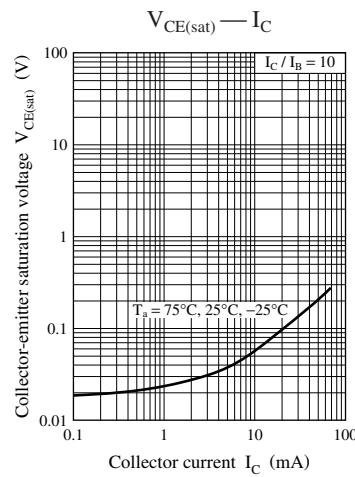
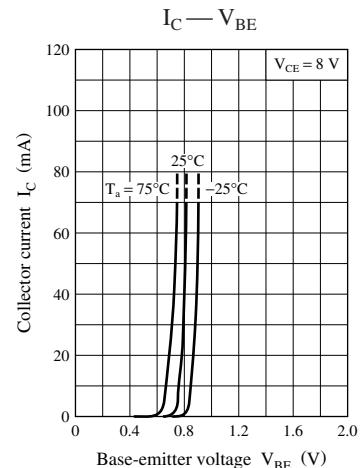
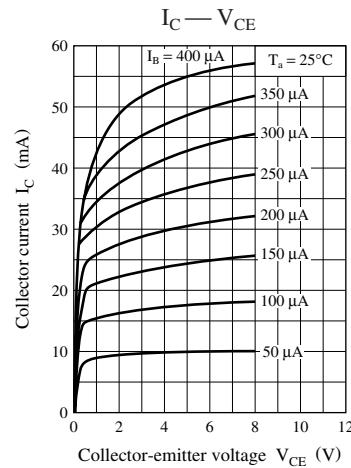
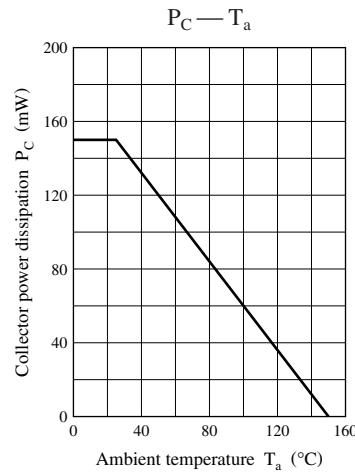
■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 15 \text{ V}$, $I_E = 0$			1	μA
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 1 \text{ V}$, $I_C = 0$			1	μA
Forward current transfer ratio	h_{FE1}	$V_{CE} = 8 \text{ V}$, $I_C = 20 \text{ mA}$	50		300	—
	h_{FE2}	$V_{CE} = 1 \text{ V}$, $I_C = 3 \text{ mA}$	80		280	
Transition frequency	f_T	$V_{CE} = 8 \text{ V}$, $I_C = 20 \text{ mA}$, $f = 0.8 \text{ GHz}$		6		GHz
Collector output capacitance (Common base, input open circuited)	C_{ob}	$V_{CB} = 10 \text{ V}$, $I_E = 0$, $f = 1 \text{ MHz}$		0.7	1.2	pF
Forward transfer gain	$ S_{21e} ^2$	$V_{CE} = 8 \text{ V}$, $I_C = 20 \text{ mA}$, $f = 0.8 \text{ GHz}$		13		dB
Maximum unilateral power gain	G_{UM}	$V_{CE} = 8 \text{ V}$, $I_C = 20 \text{ mA}$, $f = 0.8 \text{ GHz}$		14		dB
Noise figure	NF	$V_{CE} = 8 \text{ V}$, $I_C = 7 \text{ mA}$, $f = 0.8 \text{ GHz}$		1.0	1.7	dB

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.



Marking Symbol: 2W



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